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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/057,906	01/29/2002	Chih-Jung Ni	MR3029-11	3703	
4586 75	590 06/16/2005		EXAMINER		
ROSENBERG, KLEIN & LEE			EL ARINI, ZEINAB		
3458 ELLICOTT CENTER DRIVE-SUITE 101					
	TY, MD 21043		ART UNIT	PAPER NUMBER	
		•	1746		

DATE MAILED: 06/16/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

		- · · · · · · · · · · · · · · · · · · ·					
		Application No	o. Applicar	nt(s)			
		10/057,906	NI ET AL				
•	Office Action Summary	Examiner	Art Unit				
		Zeinab E. EL-A			·		
Period fo	The MAILING DATE of this community or Reply	ication appears on the cove	er sheet with the correspond	dence addres	S		
THE - Exte after - If the - If NC - Failt Any	ORTENED STATUTORY PERIOD FOR MAILING DATE OF THIS COMMUNI INSIGN SOLY (6) MONTHS from the mailing date of this common period for reply specified above is less than thirty (30 period for reply is specified above, the maximum stature to reply within the set or extended period for reply reply received by the Office later than three months a ed patent term adjustment. See 37 CFR 1.704(b).	CATION. of 37 CFR 1.136(a). In no event, how unication. b) days, a reply within the statutory m tutory period will apply and will expire will, by statute, cause the application	vever, may a reply be timely filed inimum of thirty (30) days will be cons s SIX (6) MONTHS from the mailing do to become ABANDONED (35 U.S.C.	idered timely. ate of this commur § 133).	nication.		
Status							
1)⊠	Responsive to communication(s) file	d on <i>04 April 2005</i> .					
· · · · · ·		2b)☐ This action is non-fir	nal.				
3)□	Since this application is in condition for allowance except for formal matters, prosecution as to the ments is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Disposit	ion of Claims						
5)□ 6)⊠ 7)□	Claim(s) <u>26,27,29,31,33-38 and 40-5</u> 4a) Of the above claim(s) is/ar Claim(s) is/are allowed. Claim(s) <u>26-27, 29, 31, 33-38, and 4</u> Claim(s) is/are objected to. Claim(s) are subject to restrict	re withdrawn from conside 0-50 is/are rejected.	ration.				
Applicat	ion Papers	•					
10)	The specification is objected to by the The drawing(s) filed on is/are: Applicant may not request that any object Replacement drawing sheet(s) including The oath or declaration is objected to	a) ☐ accepted or b) ☐ obtion to the drawing(s) be held the correction is required if the	he drawing(s) is objected to. S	1.85(a). See 37 CFR 1.			
Priority (under 35 U.S.C. § 119						
a)	Acknowledgment is made of a claim and all b) Some * c) None of: 1. Certified copies of the priority 2. Certified copies of the priority 3. Copies of the certified copies of application from the Internation See the attached detailed Office action	documents have been rec documents have been rec of the priority documents h nal Bureau (PCT Rule 17.3	eived. eived in Application No lave been received in this I 2(a)).		je [.]		
Attachmen	•						
2) Notice 3) Inform	te of References Cited (PTO-892) te of Draftsperson's Patent Drawing Review (Pi mation Disclosure Statement(s) (PTO-1449 or ir No(s)/Mail Date	TO-948) PTO/SB/08) 5)	Interview Summary (PTO-413) Paper No(s)/Mail Date Notice of Informal Patent Applic Other:	ation (PTO-152))		

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DETAILED ACTION

The amendment and remarks filed 04/04/05 have been acknowledged and entered.

The rejection under 35 U.S.C. 112, second paragraph stated in paper No. 022205 has been withdrawn in view of applicants' amendment.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 26, 33-37, and 40-50 are rejected under 35 U.S.C. 103(a) as being unpatentable over Applicant's

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disclosure in combination with Torek et al. (6,562,726 or 6,453,914).

Applicant admitted that the conventional method includes all limitations with the exception of the inert gas.

Torek et al ('726 or '914) teach a method for cleaning a wafer comprising using a cleaning solution, and then rinsing, and the rinsing bath may be agitated by introduction of a gas such as nitrogen, and drying the substrate.

It would have been obvious for one skilled in the art to use the gas to agitate the rinsing solution to improve the conventional cleaning process.

Applicant's disclosure in combination with Torek et al. do not teach the steps of placing the wafer over said

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stripping solution at least about 100 seconds so as to render said stripping solution left on said wafer dripping, and placing the wafer over a first organic solvent at least 50 seconds so as to render said stripping solution and said first organic solvent left on said wafer dripping down as claimed.

It is well known in the art to withdraw the wafer slowly from the cleaning solution to improve the cleaning process, by dripping most of the cleaning solution before transferring the wafer to a second cleaning or drying solution. One skill in the art would adjust the time to remove the wafer from the stripping solution, and the second cleaning solution, so as to drip most of the stripping solution and organic solution, to obtain optimum

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results. This is because the time taken for removing the wafer slowly from the cleaning solutions is functionally equivalent to the time taken to place the wafer over the stripping solutions.

Claims 26-27, 29, 31, 33-38, and 40-50 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lee in combination with Torek et al.

Lee teaches a method for removing polymer residues from a surface of a substrate comprising immersing the wafer in a stripping solution, the stripping solution comprises a hydroxylamine compound, an alcohol amine compound, an anti-corrosion agent, dihydroxybenzene, and water for a time and temperature

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sufficient to remove the polymeric residues from the surface of substrate. The reference teaches rinsing the substrate with organic solvent, followed by deionized water rinse, and the drying the substrate. See the abstract, col. 1, line 61- col. 2, line 59, col. 3, lines 23-51, col. 5, line 13- col. 6, line 5, examples 2 and 10, and the document in general.

Lee does not teach the time, providing gas to rinsing solution, and the second solvent as claimed.

Torek et al. as discussed supra teach using a gas such as nitrogen to agitate the rinsing solution. See col. 3, line 56- col. 4, line 57, and claims 1, 16-19, 28, 30-38, and the document in general.

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It would have been obvious for one skilled in the art to use the gas taught by Torek et al. in the Lee's process to enhance the rinsing process and to enhance removing the stripping solution from the substrate. It would have been obvious for one skilled in the art to repeat the rinsing step to enhance the removing of the residues and the stripping and rinsing solution from the surface of the substrate. It would have been obvious for one skilled in the art to adjust the stripping time, the rinsing time to obtain optimum results. This is because the time is determined based on particular material being removed. See Lee, col. 5, lines 49-67.

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Lee in combination with Torek et al. teach all limitations with the exception of the placing steps as claimed.

It would have been obvious for one skilled in the art to adjust the time between removing and immersing the substrate in Lee process to allow stripping solution to drip over the stripping solution, and over the solvent as claimed. This is because it is well known in the art to withdraw the wafer slowly from the cleaning solution to improve the cleaning process, by dripping most of the cleaning solution before transferring the wafer to a second cleaning or drying solution. One skill in the art would adjust the time to remove the wafer from the stripping solution, and the second cleaning solution, so as to drip

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most of the stripping solution and organic solution, to obtain optimum results. This is because the time taken for removing the wafer slowly from the cleaning solutions is functionally equivalent to the time taken to place the wafer over the stripping solutions.

These rejections stated in paper No. 022205 are maintained.

Response to Arguments

1. Applicant's arguments filed 04/04/05 have been fully considered but they are not persuasive. Applicants' argument regarding the immersion time, the drip dry time, and the second immersion time is unpersuasive, because one of ordinary skill in the art at the time applicants invented the claimed process would adjust the time to

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remove the wafer from the stripping solution, and the second cleaning solution, so as to strip most of the stripping solution and organic solution to obtain optimum results. It is well known in the art to withdraw the wafer slowly from the cleaning solution to improve the cleaning process, by dripping most of the cleaning solution before transferring the wafer to a second cleaning or drying solution.

Conclusion

2. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing

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date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to

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Zeinab E. EL-Arini whose telephone number is (571) 272-1301. The examiner can normally be reached on Monday-Friday.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael Barr can be reached on (571) 272-1414. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Zeinab E. EL-Arini Primary Examiner Art Unit 1746

ZEE 06/10/05